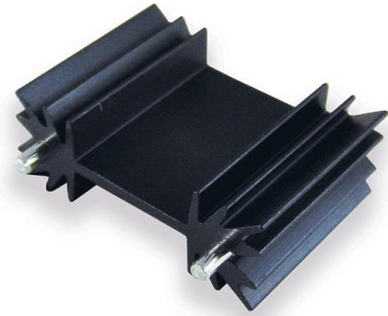


Product Data Sheet Type: **PR32/25,4/MC**

Group: HEATSINKS Board Level

For single mounting

Width : 35 mm
 Height : 12.7 mm
 Length : 25.4 mm
 Minimum thermal resistance : 14 K/W
 For device : TO 220|TO 218|TOP 3|TO
 Device mounted by : Clip Mounting
 Heatsink mounted by : Solder
 Surface : Black Anodised
 Material : AlMgSi0,5



- Special extruded heatsink for semiconductor case TO220, TO202, TO218(TOP3)
- Aluminium, anodised black, solderable
- Standard heights: 25.4, 38.1 and 50.8 mm
- Version MC (Mounting clip) for clip mounting of semiconductor.
- Heatsink solderable by tin plated solder pins

